onsemi

MOSFET – N-Channel, POWERTRENCH[®]

100 V, 300 A, 2.0 m Ω

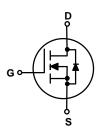
FDBL86062-F085

Features

- Typical $R_{DS(on)} = 1.5 \text{ m}\Omega$ at $V_{GS} = 10 \text{ V}$, $I_D = 80 \text{ A}$
- Typical $Q_{g(tot)} = 95 \text{ nC}$ at $V_{GS} = 10 \text{ V}$, $I_D = 80 \text{ A}$
- UIS Capability
- Qualified to AEC Q101
- This Device is Pb–Free and is RoHS Compliant

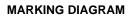
Applications

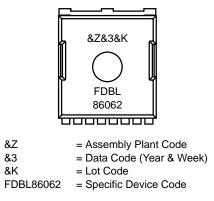
- Automotive Engine Control
- PowerTrain Management
- Solenoid and Motor Drivers
- Integrated Starter/Alternator
- Primary Switch for 12 V Systems





H-PSOF8L 11.68x9.80 CASE 100CU





ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

MOSFET MAXIMUM RATINGS $T_J = 25^{\circ}C$ unless otherwise noted

Symbol	Parameter	Parameter		Units
V _{DSS}	Drain-to-Source Voltage		100	V
V _{GS}	Gate-to-Source Voltage		±20	V
Ι _D	Drain Current - Continuous (V _{GS} = 10) (Note 1)	$T_C = 25^{\circ}C$	300	А
	Pulsed Drain Current	$T_C = 25^{\circ}C$	See Figure 4	
E _{AS}	Single Pulse Avalanche Energy (Note 2)		352	mJ
PD	Power Dissipation		429	W
	Derate Above 25°C		2.9	W/°C
T _J , T _{STG}	Operating and Storage Temperature		-55 to +175	°C
$R_{ extsf{ heta}JC}$	Thermal Resistance, Junction to Case		0.35	°C/W
R_{\thetaJA}	Maximum Thermal Resistance, Junction to Ambient (Note 3)		43	°C/W

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

Current is limited by silicon.
Starting T_J = 25°C, L = 0.1 mH, I_{AS} = 84 A, V_{DD} = 100 V during inductor charging and V_{DD} = 0 V during time in avalanche.
R_{θJA} is the sum of the junction-to-case and case-to-ambient thermal resistance, where the case thermal reference is defined as the solder mounting surface of the drain pins. R_{θJC} is guaranteed by design, while R_{θJA} is determined by the board design. The maximum rating presented here is based on mounting on a 1 in² pad of 2oz copper.

PACKAGE MARKING AND ORDERING INFORMATION

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDBL86062	FDBL86062-F085	H-PSOF8L	13"	24 mm	2000 Units

ELECTRICAL CHARACTERISTICS $T_J = 25^{\circ}C$, unless otherwise noted

Symbol	Parameter		Test Conditions	Min.	Тур.	Max.	Units	
OFF CHARACTERISTICS								
B _{VDSS}	Drain-to-Source Breakdown Voltage	$I_D = 250 \ \mu A, \ V_{GS} =$	= 0 V	100	_	-	V	
I _{DSS}	Drain-to-Source Leakage Current	$V_{GS} = 0 V$	$T_J = 25^{\circ}C$	-	-	5	μΑ	
			T _J = 175°C (Note 4)	-	-	2	mA	
I _{GSS}	Gate-to-Source Leakage Current	$V_{GS} = \pm 20 V$		_	_	±100	nA	
IGSS			<u> </u>	-	-	÷	2	

ON CHARACTERISTICS

V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_D = 250 \ \mu A$		2.0	3.1	4.5	V
R _{DS(on)}	Drain to Source On Resistance	$I_{\rm D} = 80 \rm A,$	$T_J = 25^{\circ}C$	-	1.5	2.0	mΩ
		V _{GS} = 10 V	T _J = 175°C (Note 4)	_	3.3	4.3	

DYNAMIC CHARACTERISTICS

C _{iss}	Input Capacitance	$V_{DS} = 50 \text{ V}, V_{GS} = 0 \text{ V},$		-	6970	-	pF
C _{oss}	Output Capacitance	T = 1 MHZ	f = 1 MHz		3950	-	
C _{rss}	Reverse Transfer Capacitance	The second se		-	29	-	
Rg	Gate Resistance	f = 1 MHz		-	0.4	-	Ω
Q _{g(ToT)}	Total Gate Charge at 10 V	$V_{GS} = 0$ to 10 V	$V_{DD} = 80 V$	-	95	124	nC
Q _{g(th)}	Threshold Gate Charge	$V_{GS} = 0$ to 2 V	I _D = 80 A	-	13	-	
Q _{gs}	Gate-to-Source Gate Charge			-	31	-	
Q _{gd}	Gate-to-Drain "Miller" Charge			-	20	-	

ELECTRICAL CHARACTERISTICS (continued) $T_J = 25^{\circ}C$, unless otherwise noted

Symbol	Parameter		Test Conditions	Min.	Тур.	Max.	Units			
SWITCHING CHARACTERISTICS										
t _{on}	Turn–On Time	$V_{DD} = 50 \text{ V}, \text{ I}_{D} = 80 \text{ V}_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 10 \text{ V}$	A,	-	-	73	ns			
t _{d(on)}	Turn–On Delay	$V_{GS} = 10 V, R_{GEN}$	$V_{GS} = 10 V, R_{GEN} = 6 \Omega$	-	31	-				
t _r	Rise Time			-	25	-				
t _{d(off)}	Turn–Off Delay			-	36	-				
t _f	Fall Time			-	9	-				
t _{off}	Turn-Off Time	7		-	-	59				
RAIN-SOURCE DIODE CHARACTERISTICS										

V_{SD}	Source-to-Drain Diode Voltage	$I_{SD} = 80 \text{ A}, V_{GS} = 0 \text{ V}$	-	_	1.25	V
		$I_{SD} = 40 \text{ A}, \text{ V}_{GS} = 0 \text{ V}$	-	-	1.2	
t _{rr}	Reverse–Recovery Time	I_F = 80 A, dI_{SD}/dt = 100 A/µs, V_{DD} = 80 V	-	115	150	ns
Q _{rr}	Reverse–Recovery Charge		_	172	224	nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 4. The maximum value is specified by design at $T_J = 175^{\circ}$ C. Product is not tested to this condition in production.

TYPICAL CHARACTERISTICS

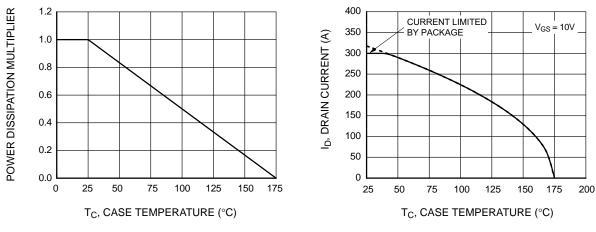


Figure 1. Normalized Power Dissipation vs. Case Temperature

Figure 2. Maximum Continuous Drain Current vs. Case Temperature

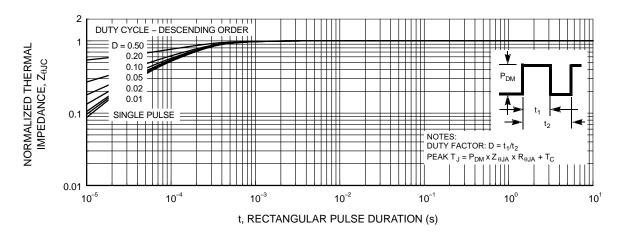
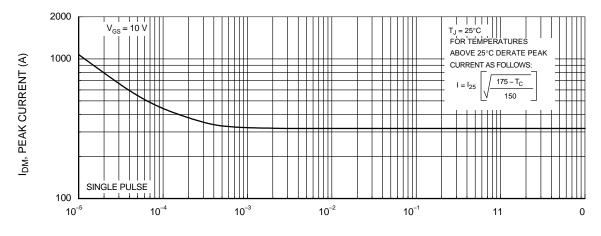


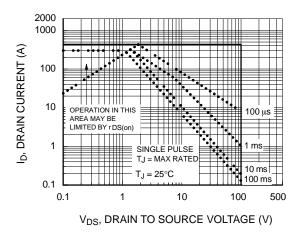
Figure 3. Normalized Maximum Transient Thermal Impedance



t, RECTANGULAR PULSE DURATION (s)

Figure 4. Peak Current Capability

TYPICAL CHARACTERISTICS (CONTINUED)







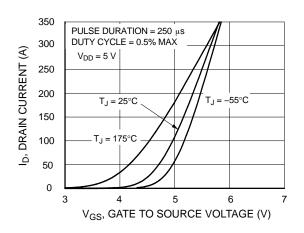


Figure 7. Transfer Characteristics

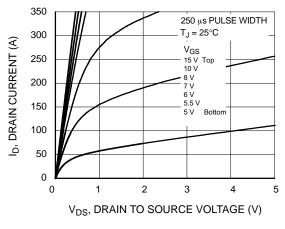


Figure 9. Saturation Characteristics

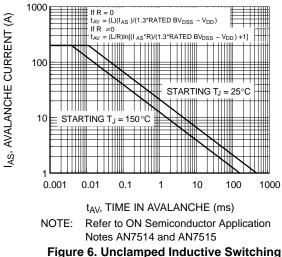


Figure 6. Unclamped inductive Switching Capability

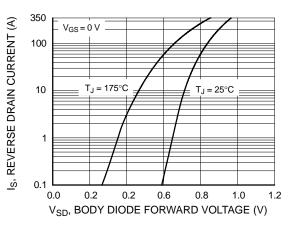
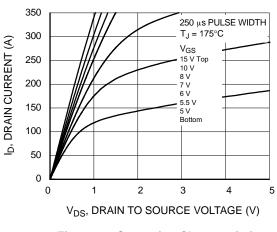
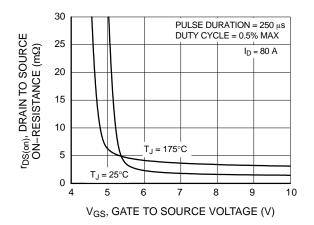


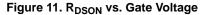
Figure 8. Forward Diode Characteristics





TYPICAL CHARACTERISTICS (CONTINUED)





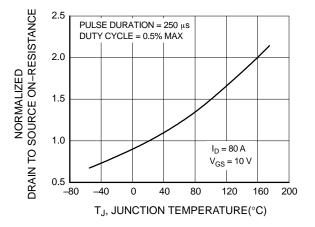


Figure 12. Normalized R_{DSON} vs. Junction Temperature

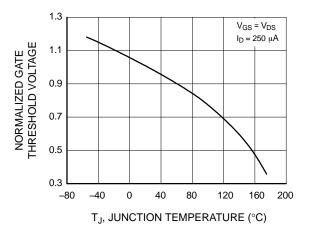
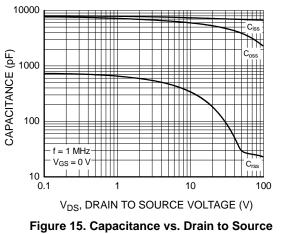


Figure 13. Normalized Gate Threshold Voltage vs. Temperature



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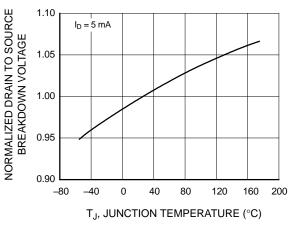
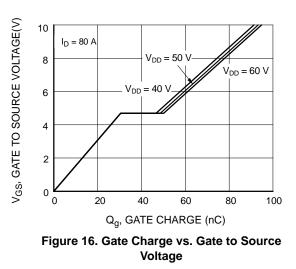
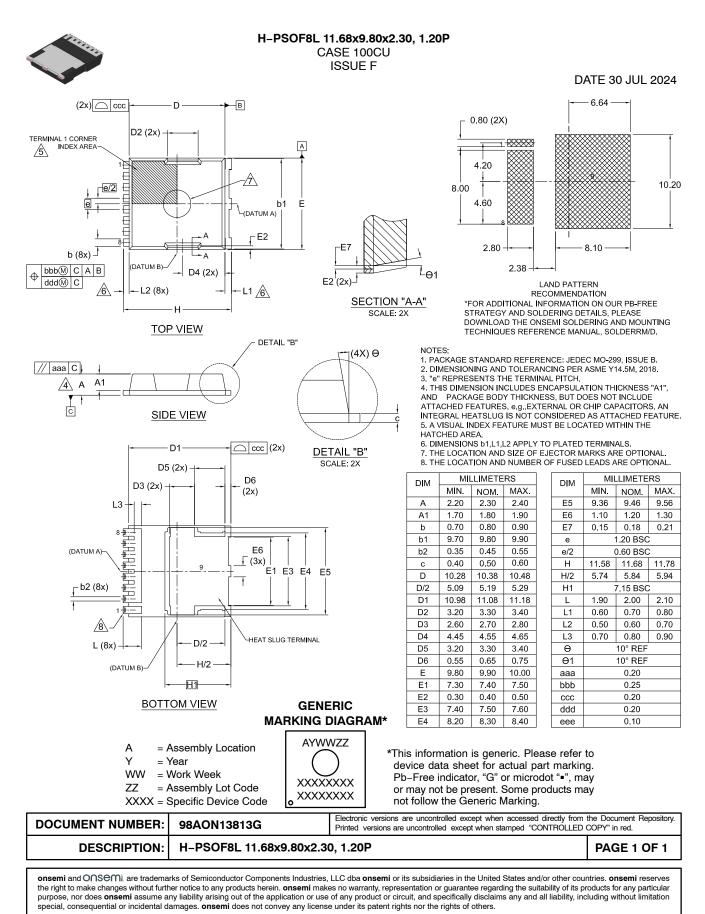


Figure 14. Normalized Drain to Source Breakdown Voltage vs. Junction Temperature



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